International TOR Rectifier

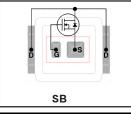
AUTOMOTIVE GRADE

AUIRF7665S2TR AUIRF7665S2TR1

- Advanced Process Technology
- Optimized for Class D Audio Amplifier Applications
- Low Rds(on) for Improved Efficiency
- Low Qg for Better THD and Improved Efficiency
- Low Qrr for Better THD and Lower EMI
- Low Parasitic Inductance for Reduced Ringing and Lower EMI
- Delivers up to 100W per Channel into 8W with No Heatsink
- Dual Sided Cooling
- 175°C Operating Temperature
- Repetitive Avalanche Capability for Robustness and Reliability
- Lead free, RoHS and Halogen free

DirectFET™ Power MOSFET ②

V _{(BR)DSS}	100V		
R _{DS(on)} typ.	51m Ω		
max.	62mΩ		
R _{G (typical)}	3.5Ω		
Q _{g (typical)}	8.3nC		





Applicable DirectFET Outline and Substrate Outline ①

SB	SC		M2	M4	L4	L6	L8	

Description

The AUIRF7665S2 combines the latest Automotive HEXFET® Power MOSFET Silicon technology with the advanced DirectFET packaging platform to produce a best in class part for Automotive Class D audio amplifier applications. The DirectFET package is compatible with existing layout geometries used in power applications, PCB assembly equipment and vapor phase, infra-red or convection soldering techniques, when application note AN-1035 is followed regarding the manufacturing methods and processes. The DirectFET package allows dual sided cooling to maximize thermal transfer in automotive power systems.

This HEXFET Power MOSFET optimizes gate charge, body diode reverse recovery and internal gate resistance to improve key Class D audio amplifier performance factors such as efficiency, THD and EMI. Moreover the DirectFET packaging platform offers low parasitic inductance and resistance when compared to conventional wire bonded SOIC packages which improves EMI performance by reducing the voltage ringing that accompanies current transients.

These features combine to make this MOSFET a highly desirable component in Automotive Class D audio amplifier systems.

Absolute Maximum Ratings

	Parameter	Max.	Units	
V _{DS}	Drain-to-Source Voltage	100		
V_{GS}	Gate-to-Source Voltage	± 20	 	
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited) ^④	14.4		
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited) ^④	10.2	1	
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)3	4.1	A	
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V (Package Limited)	77	1	
DM	Pulsed Drain Current ®	58	<u> </u>	
P _D @T _C = 25°C	Power Dissipation ④	30	w	
P _D @T _A = 25°C	Power Dissipation ③	2.4	VV	
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) ®	37	mJ	
AS(tested)	Single Pulse Avalanche Energy (Tested Value) ®	56	1110	
AR	Avalanche Current S	See Fig. 18a,18b,16,17	Α	
E _{AR}	Repetitive Avalanche Energy ©	See Fig. 16a, 16b, 16, 17	mJ	
T _P	Peak Soldering Temperature	270		
T_J	Operating Junction and	-55 to + 175	°C	
T _{STG}	Storage Temperature Range			

Thermal Resistance

Thermal resistance								
	Parameter	Тур.	Max.	Units				
$R_{\theta JA}$	Junction-to-Ambient ③		63					
$R_{\theta JA}$	Junction-to-Ambient ®	12.5						
$R_{ heta JA}$	Junction-to-Ambient ®	20 —		°C/W				
R _{θJ-Can}	Junction-to-Can ⊕®	<u> </u>						
R _{0J-PCB}	Junction-to-PCB Mounted	1.4						
	Linear Derating Factor ®	0.	.2	W/°C				

HEXFET® is a registered trademark of International Rectifier.

Static @ T_J = 25°C (unless otherwise specified)

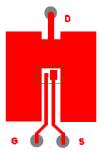
	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	100			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.10		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance	_	51	62	mΩ	V _{GS} = 10V, I _D = 8.9A ⑦
V _{GS(th)}	Gate Threshold Voltage	3.0	4.0	5.0	V	$V_{DS} = V_{GS}, I_{D} = 25\mu A$
$\Delta V_{GS(th)}/\Delta T_{J}$	Gate Threshold Voltage Coefficient		-13		mV/°C	V _{DS} = V _{GS} , I _D = 25μA
gfs	Forward Transconductance	8.8			S	$V_{DS} = 25V, I_{D} = 8.9A$
R _{G(int)}	Internal Gate Resistance		3.5	5.0	Ω	
I _{DSS}	Drain-to-Source Leakage Current			5	μΑ	$V_{DS} = 100V, V_{GS} = 0V$
				250		$V_{DS} = 80V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
GSS	Gate-to-Source Forward Leakage			100	nA	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage			-100	1	V _{GS} = -20V

Dynamic @ T_J = 25°C (unless otherwise specified)

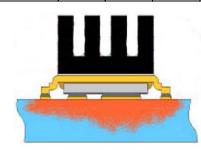
	Parameter	Min.	Тур.	Max.	Units	Conditions
				_	Omis	
Q _g	Total Gate Charge		8.3	13		$V_{DS} = 50V$
Q _{gs1}	Pre-Vth Gate-to-Source Charge		1.9			$V_{GS} = 10V$
Q_{gs2}	Post-Vth Gate-to-Source Charge		0.77		nC	$I_D = 8.9A$
Q_{gd}	Gate-to-Drain Charge		3.2		110	See Fig. 11
Q_{godr}	Gate Charge Overdrive		2.4			
Q _{sw}	Switch Charge (Q _{gs2} + Q _{gd})		4.0			
Q _{oss}	Output Charge		4.7		nC	V _{DS} = 16V, V _{GS} = 0V
t _{d(on)}	Turn-On Delay Time		3.8			$V_{DD} = 50V$
t _r	Rise Time		6.4			$I_D = 8.9A$
t _{d(off)}	Turn-Off Delay Time		7.1		ns	$R_G = 6.8\Omega$
t _f	Fall Time		3.6			V _{GS} = 10V ⑦
C _{iss}	Input Capacitance		515			$V_{GS} = 0V$
C _{oss}	Output Capacitance		110			$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		30		pF	f = 1.0MHz
C _{oss}	Output Capacitance		530			$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
C _{oss}	Output Capacitance		70			$V_{GS} = 0V, V_{DS} = 80V, f = 1.0MHz$
C _{oss} eff.	Effective Output Capacitance		115			$V_{GS} = 0V$, $V_{DS} = 0V$ to $80V$

Diode Characteristics

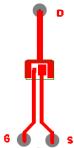
	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current			14.4		MOSFET symbol
	(Body Diode)		14.4	Α	showing the	
I _{SM}	Pulsed Source Current			58		integral reverse
	(Body Diode) ^⑤			36		p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	V	$T_J = 25$ °C, $I_S = 8.9$ A, $V_{GS} = 0$ V ⑦
t _{rr}	Reverse Recovery Time		33		ns	$T_J = 25$ °C, $I_F = 8.9$ A, $V_{DD} = 25$ V
Q _{rr}	Reverse Recovery Charge		38		nC	di/dt = 100A/µs ⑦



③ Surface mounted on 1 in. square Cu (still air).



Mounted to a PCB with small clip heatsink (still air)



 Mounted on minimum footprint full size board with metalized back and with small clip heatsink (still air)

Qualification Information[†]

			Automotive		
		(per AEC-Q101) ^{††}			
Qualification Level		IR's Industrial and	art number(s) passed Automotive qualification. Consumer qualification level is granted by ner Automotive level.		
Moisture Sensitivity	/ Level	DFET2 MSL1			
	Machine Model	Class B			
			AEC-Q101-002		
FOD	Human Body Model		Class 2		
ESD			AEC-Q101-001		
	Charged Device Model		Class IV		
			AEC-Q101-005		
RoHS Compliant	•		Yes		

[†] Qualification standards can be found at International Rectifier's web site: http://www.irf.com

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^{††} Exceptions to AEC-Q101 requirements are noted in the qualification report.

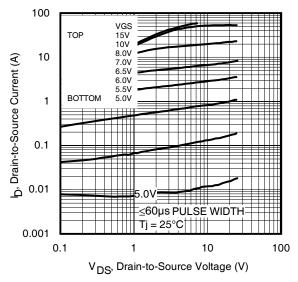
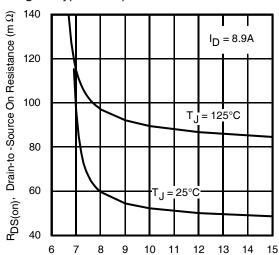


Fig 1. Typical Output Characteristics



V_{GS,} Gate -to -Source Voltage (V) **Fig 3.** Typical On-Resistance vs. Gate Voltage

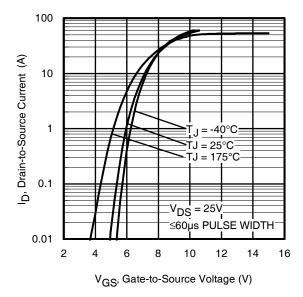


Fig 5. Typical Transfer Characteristics

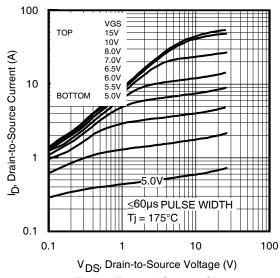


Fig 2. Typical Output Characteristics

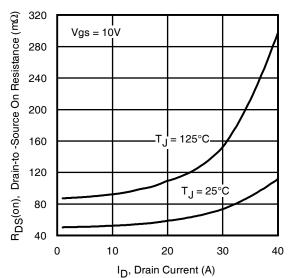


Fig 4. Typical On-Resistance vs. Drain Current

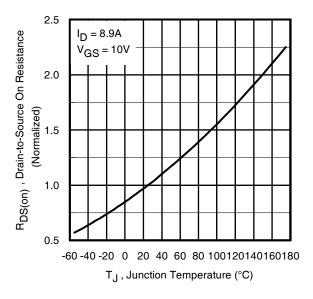


Fig 6. Normalized On-Resistance vs. Temperature www.irf.com

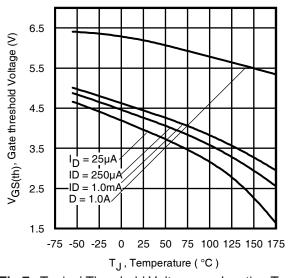


Fig 7. Typical Threshold Voltage vs. Junction Temperature

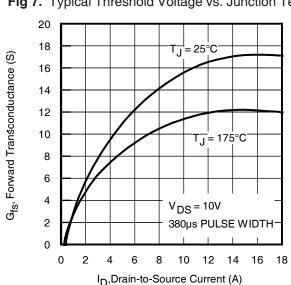


Fig 9. Typical Forward Transconductance Vs. Drain Current

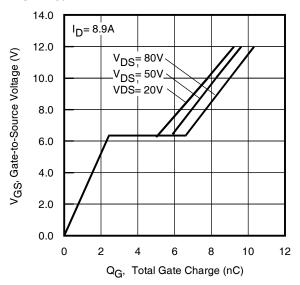


Fig.11 Typical Gate Charge vs.Gate-to-Source Voltage www.irf.com

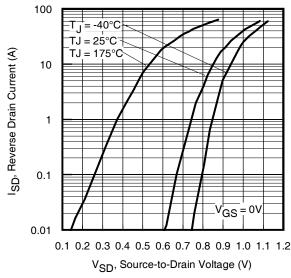


Fig 8. Typical Source-Drain Diode Forward Voltage

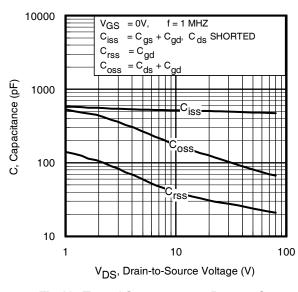


Fig 10. Typical Capacitance vs.Drain-to-Source Voltage

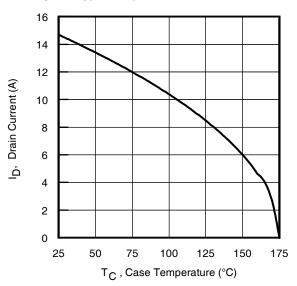


Fig 12. Maximum Drain Current vs. Case Temperature

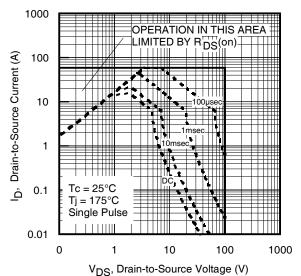


Fig 13. Maximum Safe Operating Area

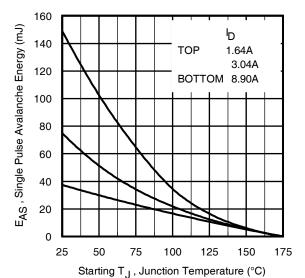


Fig 14. Maximum Avalanche Energy vs. Temperature

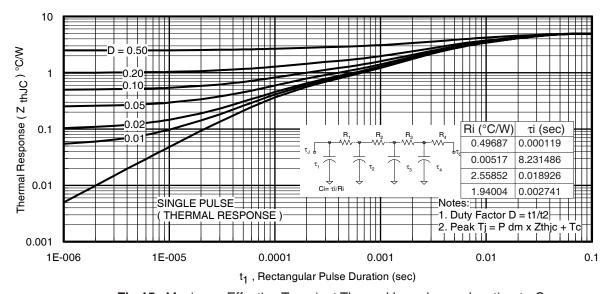


Fig 15. Maximum Effective Transient Thermal Impedance, Junction-to-Case

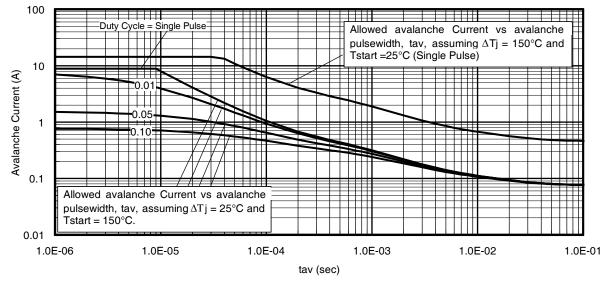


Fig 16. Typical Avalanche Current Vs.Pulsewidth

TOP Single Pulse BOTTOM 1.0% Duty Cycle 35 $I_{D} = 8.9A$ EAR , Avalanche Energy (mJ) 30 25 20 15 10 5 0 25 50 75 100 125 150 175 Starting T_{.J}, Junction Temperature (°C)

Fig 17. Maximum Avalanche Energy Vs. Temperature

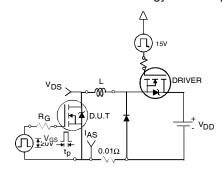


Fig 18a. Unclamped Inductive Test Circuit

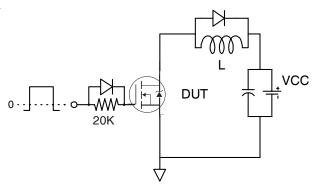


Fig 19a. Gate Charge Test Circuit

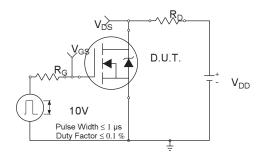


Fig 20a. Switching Time Test Circuit

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Notes on Repetitive Avalanche Curves, Figures 16, 17: (For further info, see AN-1005 at www.irf.com)

- Avalanche failures assumption:
 Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax}. This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long asT_{jmax} is not exceeded.
- Equation below based on circuit and waveforms shown in Figures 18a, 18b.
- 4. P_{D (ave)} = Average power dissipation per single avalanche pulse.
- BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 16, 17).

t_{av =} Average time in avalanche.

D = Duty cycle in avalanche = $t_{av} \cdot f$

 $Z_{th,JC}(D, t_{av})$ = Transient thermal resistance, see figure 11)

$$\begin{split} P_{D \text{ (ave)}} &= 1/2 \text{ (} 1.3 \cdot \text{BV} \cdot \text{I}_{av} \text{)} = \triangle \text{T/ Z}_{thJC} \\ I_{av} &= 2\triangle \text{T/ [1.3} \cdot \text{BV} \cdot \text{Z}_{th}] \\ E_{AS \text{ (AR)}} &= P_{D \text{ (ave)}} \cdot t_{av} \end{split}$$

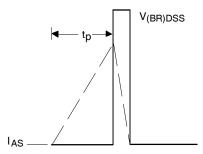


Fig 18b. Unclamped Inductive Waveforms

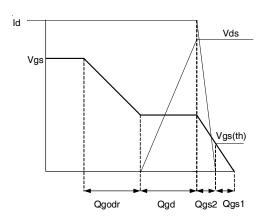


Fig 19b. Gate Charge Waveform

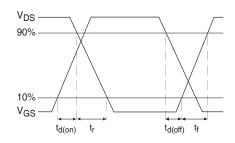
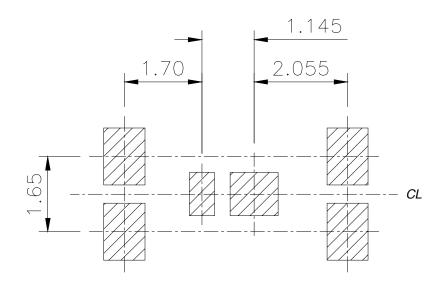
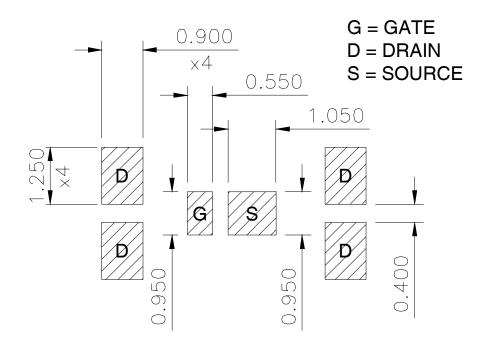


Fig 20b. Switching Time Waveforms

Automotive DirectFET™ Board Footprint, SB (Small Size Can).

Please see AN-1035 for DirectFET assembly details and stencil and substrate design recommendations

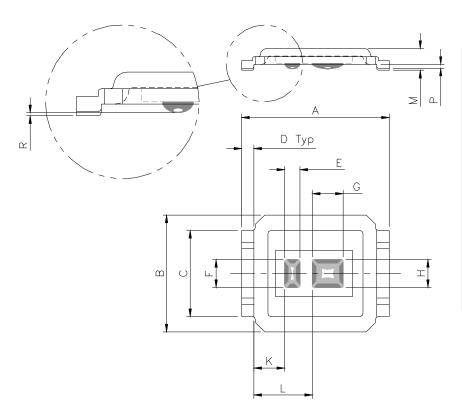




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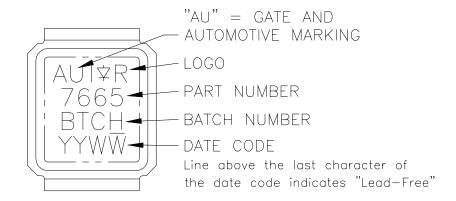
Automotive DirectFET™ Outline Dimension, SB Outline (Small Size Can).

Please see AN-1035 for DirectFET assembly details and stencil and substrate design recommendations



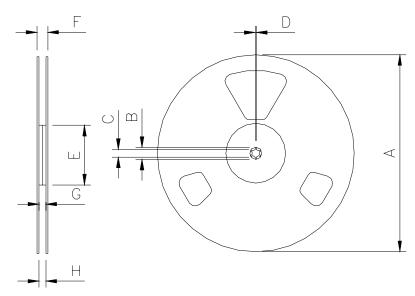
DIMENSIONS								
	MET	RIC	IMPERIAL					
CODE	MIN	MAX	MIN	MAX				
Α	4.75	4.85	0.187	0.191				
В	3.70	3.95	0.146	0.156				
С	2.75	2.85	0.108	0.112				
D	0.35	0.45	0.014	0.018				
Е	0.48	0.52	0.019	0.020				
F	0.88	0.92	0.035	0.036				
G	0.98	1.02	0.039	0.040				
Н	0.88	0.92	0.035	0.036				
J	N/A	N/A	N/A	N/A				
K	0.95	1.05	0.037	0.041				
L	1.85	1.95	0.073	0.077				
М	0.68	0.74	0.027	0.029				
Р	0.08	0.17	0.003	0.007				
R	0.02	0.08	0.001	0.003				

Automotive DirectFET™ Part Marking



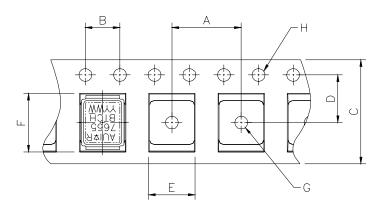
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Automotive DirectFET™ Tape & Reel Dimension (Showing component orientation).



NOTE: Controlling dimensions in mm Std reel quantity is 4800 parts. (ordered as AUIRF7665S2TR). For 1000 parts on 7" reel, order AUIRF7665S2TR1

	REEL DIMENSIONS									
S	TANDARD	OPTION	1(QTY 4	800)	TR′	OPTIO	N(QTY 1	000)		
	ME	TRIC	IMP	ERIAL	ME	TRIC	IMP	ERIAL		
CODE	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
Α	330.0	N.C	12.992	N.C	177.77	N.C	6.9	N.C		
В	20.2	N.C	0.795	N.C	19.06	N.C	0.75	N.C		
С	12.8	13.2	0.504	0.520	13.5	12.8	0.53	0.50		
D	1.5	N.C	0.059	N.C	1.5	N.C	0.059	N.C		
Е	100.0	N.C	3.937	N.C	58.72	N.C	2.31	N.C		
F	N.C	18.4	N.C	0.724	N.C	13.50	N.C	0.53		
G	12.4	14.4	0.488	0.567	11.9	12.01	0.47	N.C		
Н	11.9	15.4	0.469	0.606	11.9	12.01	0.47	N.C		



NOTE: CONTROLLING DIMENSIONS IN MM

DIMENSIONS								
	MET	RIC	IMPERIAL					
CODE	MIN	MAX	MIN	MAX				
А	7.90	8.10	0.311	0.319				
В	3.90	4.10	0.154	0.161				
С	11.90	12.30	0.469	0.484				
D	5.45	5.55	0.215	0.219				
Е	4.00	4.20	0.158	0.165				
F	5.00	5.20	0.197	0.205				
G	1.50	N.C	0.059	N.C				
Н	1.50	1,60	0.059	0.063				

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AUIRF7665S2TR/TR1

Notes:

- ① Click on this section to link to the appropriate technical paper.
- ② Click on this section to link to the DirectFET Website.
- 3 Surface mounted on 1 in. square Cu board, steady state.
- ④ T_C measured with thermocouple mounted to top (Drain) of part.
- © Starting $T_J = 25$ °C, L = 0.944mH, $R_G = 25\Omega$, $I_{AS} = 8.9$ A.
- The Pulse width $\leq 400 \mu s$; duty cycle $\leq 2\%$.
- Used double sided cooling, mounting pad with large heatsink.
- Mounted on minimum footprint full size board with metalized back and with small clip heatsink.

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